

ID No. 844	Product/Process Change Notification	Date 15.11.2021
Product	Ordering Code	
BGS2-E	L30960-N2200-Ax00 x=1,2,3,4	
	L30960-N2200-C200	
	L30960-N2200-C400	
BGS2-W	L30960-N2210-Ax00 x=1,2,3,4	
	L30960-N2215-A100	
	L30960-N2210-C400	
	L30960-N2210-E400	
Ordering Code changes:	<input checked="" type="checkbox"/> Yes <input type="checkbox"/> No	
Product	New Ordering Code	
BGS2-E	L30960-N2200-A450	
BGS2-W	L30960-N2210-A450	

Reason of Change:

- | | |
|---|--|
| <input type="checkbox"/> Technical requirement
<input type="checkbox"/> Customer requirement
<input type="checkbox"/> Quality improvement | <input type="checkbox"/> Change of production process/logistical changes
<input type="checkbox"/> Location of production moved
<input checked="" type="checkbox"/> Other: Design modification due introduction of new 2 nd source component |
|---|--|

Description of change:	Introduction of a new memory component with adaption of corresponding pcb to secure deliveries after previous memory chip supply has stopped. Module certification has been renewed.
Samples	Samples will be distributed end of November 2021
Mass production	Ramp up is scheduled for Jan 2022; First shipments are planned for Feb 2022; Existing orders for previous variants will be transferred to new versions and rescheduled.
Timing note:	If THALES DIS AIS Deutschland GmbH does not receive a notification to the contrary within a period of 6 weeks, Thales assumes that the customer agrees to the change.
Quality assurance measurements:	The new version fulfils all internal test requirements according to our Quality Management process and philosophy.

Attachments: non

X *i.v. A. Armin*

X *i. v. Joerg Erdmann*

Product Program Manager
Signed by: DIMAI Armin

Vice President Quality Management
Signed by: ERDMANN Joerg